

L Number	Hits	Search Text	DB	Time stamp
1	2	6674350.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/23 17:23
2	7898	electromagnetic adj actuator	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/23 17:23
3	32570	movable adj member	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/23 17:24
4	221090	plating	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/23 17:25
5	351	station adj member	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/23 17:25
6	0	(electromagnetic adj actuator) and (movable adj member) and (station adj member)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/23 17:26
7	290	(electromagnetic adj actuator) and (movable adj member)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/23 17:26
8	114581	silicon adj substrate	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/23 17:26
9	7	((electromagnetic adj actuator) and (movable adj member)) and (silicon adj substrate)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/23 17:36
10	9	("3503022" "3619673" "4527139" "4857781" "5107372" "5647311" "5724015" "6014240" "6054329").PN.	USPAT	2004/08/23 17:28
11	11915	stationary adj member	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/23 17:36
13	114581	silicon adj substrate	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/23 17:37
14	3	((electromagnetic adj actuator) and (movable adj member) and (stationary adj member)) and (silicon adj substrate)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/23 17:37
12	25	(electromagnetic adj actuator) and (movable adj member) and (stationary adj member)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/23 18:04
15	221090	plating	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/23 18:05
16	69889	photolithography	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/23 18:05
17	7464	plating and photolithography	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/23 18:05

18	3	(plating and photolithography) and (stationary adj member) and (silicon adj substrate)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/23 18:06
19	22	(plating and photolithography) and (electromagnetic adj actuator)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/23 18:25
20	2	("4421381" "5378653").PN.	USPAT	2004/08/23 18:07
21	4	("4421381" "4937226" "5116457" "5767666").PN.	USPAT	2004/08/23 18:13
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23	4	("4421381" "4937226" "5116457" "5767666").PN.	USPAT	2004/08/23 18:14
24	4	("4421381" "4937226" "5116457" "5767666").PN.	USPAT	2004/08/23 18:16
25	194	29/595.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/23 18:26
26	3012	29/596.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/23 18:26
27	4	29/595.ccls. and 29/596.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/23 18:26
28	483	324/97.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/23 18:26
29	1782	324/96.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/23 18:27
30	16	324/97.ccls. and 324/96.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/23 18:27
31	240	335/256.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/23 18:27
32	584	335/220.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/23 18:27
33	3	335/256.ccls. and 335/220.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/23 18:28
34	26	334/2.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/23 18:29
35	584	335/220.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/23 18:29

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33	3	335/256.ccls. and 335/220.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/23 18:30
34	26	334/2.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/23 18:29
35	584	335/220.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/23 18:29
36	2	6124923.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/23 18:31
37	2	4752757.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/23 18:31

38	2	6054329.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/23 18:32
39	4	4421381.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/08/23 18:32